

Data Sheet

December 21, 2005

FN3118.4

## SPST 4-Channel Analog Switch

The DG211 is a low cost, CMOS monolithic, Quad SPST analog switch. It can be used in general purpose switching applications for communications, instrumentation, process control and computer peripheral equipment and provides true bidirectional performance in the ON condition and blocks signals to  $30V_{P-P}$  in the OFF condition.

# Part Number Information

| PART<br>NUMBER           | PART<br>MARKING | TEMP.<br>RANGE (°C) | PACKAGE                  | PKG. NO. |
|--------------------------|-----------------|---------------------|--------------------------|----------|
| DG211CJ                  | DG211CJ         | 0 to 70             | 16 Ld PDIP               | E16.3    |
| DG211CJZ<br>(Notes 1, 2) | DG211CJZ        | 0 to 70             | 16 Ld PDIP*<br>(Pb-free) | E16.3    |
| DG211CY<br>(Note 2)      | DG211CY         | 0 to 70             | 16 Ld SOIC               | M16.15   |
| DG211CYZ<br>(Notes 1, 2) | DG211CYZ        | 0 to 70             | 16 Ld SOIC<br>(Pb-free)  | M16.15   |

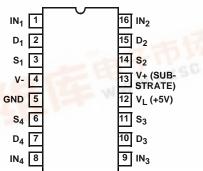
<sup>\*</sup>Pb-free PDIPs can be used for through hole wave solder processing only. They are not intended for use in Reflow solder processing applications.

#### NOTES:

- Intersil Pb-free plus anneal products employ special Pb-free material sets; molding compounds/die attach materials and 100% matte tin plate termination finish, which are RoHS compliant and compatible with both SnPb and Pb-free soldering operations. Intersil Pb-free products are MSL classified at Pb-free peak reflow temperatures that meet or exceed the Pb-free requirements of IPC/JEDEC J STD-020.
- 2. Add "T" suffix for Tape and Reel.

### **Pinout**

DG211 (PDIP, SOIC) TOP VIEW

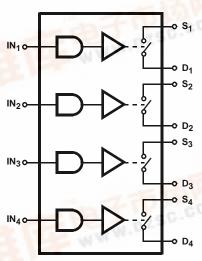


#### Features

- Switches ±15V Analog Signals
- TTL Compatibility
- Logic Inputs Accept Negative Voltages
- · Pb-Free Plus Anneal Available (RoHS Compliant)

# Functional Block Diagrams

DG211



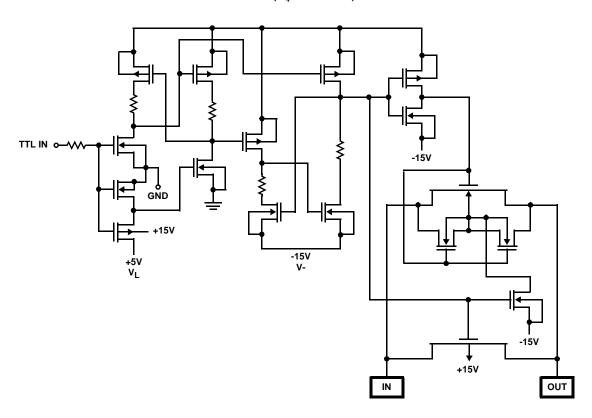
#### TRUTH TABLE

| LOGIC | DG211 |
|-------|-------|
| 0     | ON    |
| 1     | OFF   |

Logic "0" ≤0.8V, Logic "1" ≥ 2.4V

# Schematic Diagram

# DG211 (<sup>1</sup>/<sub>4</sub> AS SHOWN)



### **Absolute Maximum Ratings**

| V+ to V  |
|--|
| V <sub>IN</sub> to Ground                                  |
| V <sub>L</sub> to Ground0.3V to 25V                        |
| V <sub>S</sub> or V <sub>D</sub> to V+ 0 to -36V           |
| V <sub>S</sub> or V <sub>D</sub> to V                      |
| V+ to Ground   |
| V- to Ground25V  |
| Current, any Terminal Except S or D                        |
| Continuous Current, S or D                                 |
| Peak Current, S or D (Pulsed 1ms, 10% Duty Cycle Max) 70mA |

### **Thermal Information**

| Thermal Resistance (Typical, Note 3)     | $\theta_{JA}$ (°C/W) |
|--|----------------------|
| PDIP Package*                            | 100                  |
| SOIC Package                             |                      |
| Maximum Junction Temperature             | 150°C                |
| Maximum Storage Temperature Range65      | 5°C to 150°C         |
| Maximum Lead Temperature (Soldering 10s) | 300°C                |
| (SOIC - Lead Tips Only)                  |                      |

\*Pb-free PDIPs can be used for through hole wave solder processing only. They are not intended for use in Reflow solder processing applications.

# **Operating Conditions**

Temperature Range . . . . . . . . . . . . 0 °C to 70 °C

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

#### NOTE

3.  $\theta_{JA}$  is measured with the component mounted on an evaluation PC board in free air.

# **Electrical Specifications** V+ = +15V, V- = -15V, $V_L$ = +5V, GND, $T_A$ = 25°C

| PARAMETER   | TE   | TEST CONDITIONS                                 |      | (NOTE 5) | MAX | UNITS |
|---|--|---|------|----------|-----|-------|
| DYNAMIC CHARACTERISTICS   |  |   |      |          |     |       |
| Turn-ON Time, t <sub>ON</sub>                                   | See Figure 1   | -   | 460  | -        | ns  |       |
| Turn-OFF Time,  | $V_{S} = 10V, R_{L} = 11$  | $V_S = 10V, R_L = 1k\Omega, C_L = 35pF$         |      |          |     |       |
| toff1   |  |   | -    | 360      | -   | ns    |
| t <sub>OFF2</sub>   |  | _   |      |          | -   | ns    |
| OFF Isolation, OIRR (Note 7)                                    |  | $\Omega$ , $C_L = 15pF$ , $V_S = 1V_{RMS}$ ,    | -    | 70       | -   | dB    |
| Crosstalk (Channel to Channel), CCRR                            | f = 100kHz   | f = 100kHz                                      |      |          | -   | dB    |
| Source OFF Capacitance, C <sub>S(OFF)</sub>                     | V <sub>D</sub> = V <sub>S</sub> = 0V, V <sub>IN</sub> = 5V, f = 1MHz |   | -    | 5        | -   | pF    |
| Drain OFF Capacitance, C <sub>D(OFF)</sub>                      |  | -   | 5    | -        | pF  |       |
| Channel ON Capacitance, C <sub>D(ON)</sub> + C <sub>S(ON)</sub> |  | -   | 16   | -        | pF  |       |
| DIGITAL INPUT CHARACTERISTICS                                   |  |   |      | 1        |     |       |
| Input Current with Voltage High, I <sub>IH</sub>                | V <sub>IN</sub> = 2.4V   |   | -1.0 | -0.0004  | -   | μА    |
|   | V <sub>IN</sub> = 15V  |   | -    | 0.003    | 1.0 | μА    |
| Input Current with Voltage Low, I <sub>IL</sub>                 | V <sub>IN</sub> = 0V   | V <sub>IN</sub> = 0V                            |      | -0.0004  | -   | μА    |
| ANALOG SWITCH CHARACTERISTICS                                   | 1  |   |      | 1        |     |       |
| Analog Signal Range, V <sub>ANALOG</sub>                        |  |   |      | -        | 15  | V     |
| Drain-Source ON Resistance, r <sub>DS(ON)</sub>                 | V <sub>D</sub> = ±10V, I <sub>S</sub> = 1                            | $V_D = \pm 10V$ , $I_S = 1$ mA, $V_{IN} = 0.8V$ |      | 150      | 175 | Ω     |
| Source OFF Leakage Current, I <sub>S(OFF)</sub>                 | V <sub>IN</sub> = 2.4V   | V <sub>S</sub> = 14V, V <sub>D</sub> = -14V     | -    | 0.01     | 5.0 | nA    |
|   |  | V <sub>S</sub> = -14V, V <sub>D</sub> = 14V     | -5.0 | -0.02    | -   | nA    |
| Drain OFF Leakage Current, I <sub>D(OFF)</sub>                  |  | V <sub>S</sub> = -14V, V <sub>D</sub> = 14V     | -    | 0.01     | 5.0 | nA    |
|   |  | V <sub>S</sub> = 14V, V <sub>D</sub> = -14V     | -5.0 | -0.02    | -   | nA    |
| Drain ON Leakage Current, I <sub>D(ON)</sub>                    | V <sub>IN</sub> = 0.8V   | V <sub>S</sub> = V <sub>D</sub> = 14V           | -    | 0.1      | 5.0 | nA    |
| (Note 6)  |  | $V_{S} = V_{D} = -14V$                          |      | -0.15    | -   | nA    |

## Electrical Specifications V+ = +15V, V- = -15V, $V_L = +5V$ , GND, $T_A = 25^{\circ}C$ (Continued)

| PARAMETER                            | TEST CONDITIONS              | (NOTE 4)<br>MIN | (NOTE 5)<br>TYP | MAX | UNITS |
|--------------------------------------|------------------------------|-----------------|-----------------|-----|-------|
| POWER SUPPLY CHARACTERISTICS         |                              |                 |                 |     |       |
| Positive Supply Current, I+          | V <sub>IN</sub> = 0V or 2.4V | -               | 0.1             | 10  | μА    |
| Negative Supply Current, I-          |                              | -               | 0.1             | 10  | μА    |
| Logic Supply Current, I <sub>L</sub> |                              | -               | 0.1             | 10  | μА    |

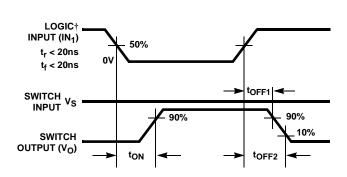
#### NOTES:

- 4. The algebraic convention whereby the most negative value is a minimum, and the most positive is a maximum, is used in this data sheet.
- 5. For design reference only, not 100% tested.
- 6.  $I_{D(ON)}$  is leakage from driver into ON switch.
- 7. OFF Isolation =  $20log \frac{V_S}{V_D}$ ,  $V_S$  = Input to OFF switch,  $V_D$  = output .

#### Test Circuits and Waveforms

Switch output waveform shown for  $V_S$  = constant with logic input waveform as shown. Note the  $V_S$  may be + or - as per switching time test circuit.  $V_O$  is the steady state output with

switch on. Feedthrough via gate capacitance may result in spikes at leading and trailing edge of output waveform.



† Logic shown for DG211.

FIGURE 1. SWITCHING TIME MEASUREMENT POINTS

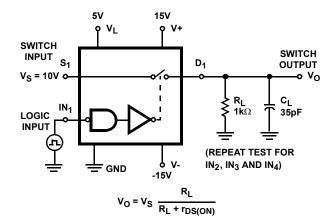


FIGURE 2. SWITCHING TIME TEST CIRCUIT

\_\_\_\_\_

## Die Characteristics

**DIE DIMENSIONS:** 

 $2159 \mu m \ x \ 2235 \mu m$ 

**METALLIZATION:** 

Type: Al

Thickness: 10kÅ ±1kÅ

### PASSIVATION:

Type: PSG/Nitride

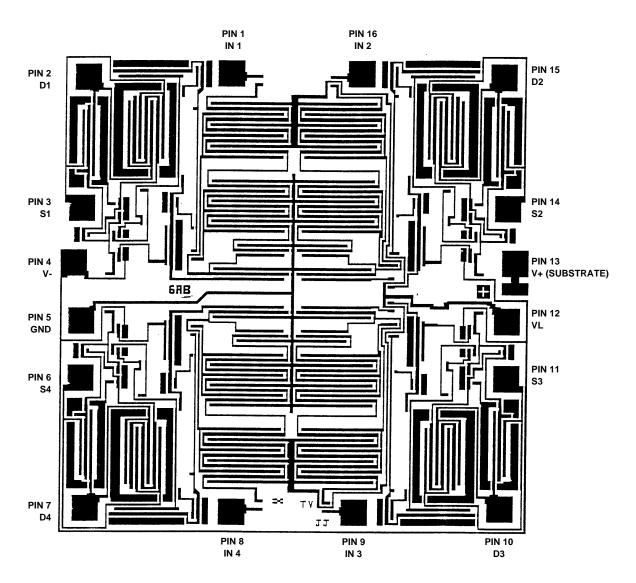
PSG Thickness: 7kÅ ±1.4kÅ Nitride Thickness: 8kÅ ±1.2kÅ

### **WORST CASE CURRENT DENSITY:**

9.1 x 10<sup>4</sup> A/cm<sup>2</sup>

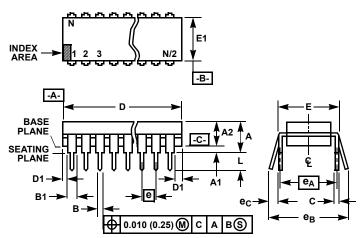
# Metallization Mask Layout

DG211



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# Dual-In-Line Plastic Packages (PDIP)



#### NOTES:

- Controlling Dimensions: INCH. In case of conflict between English and Metric dimensions, the inch dimensions control.
- 2. Dimensioning and tolerancing per ANSI Y14.5M-1982.
- 3. Symbols are defined in the "MO Series Symbol List" in Section 2.2 of Publication No. 95.
- Dimensions A, A1 and L are measured with the package seated in JE-DEC seating plane gauge GS-3.
- D, D1, and E1 dimensions do not include mold flash or protrusions.
   Mold flash or protrusions shall not exceed 0.010 inch (0.25mm).
- E and eA are measured with the leads constrained to be perpendicular to datum -C-.
- 7.  $e_B$  and  $e_C$  are measured at the lead tips with the leads unconstrained.  $e_C$  must be zero or greater.
- B1 maximum dimensions do not include dambar protrusions. Dambar protrusions shall not exceed 0.010 inch (0.25mm).
- 9. N is the maximum number of terminal positions.
- Corner leads (1, N, N/2 and N/2 + 1) for E8.3, E16.3, E18.3, E28.3, E42.6 will have a B1 dimension of 0.030 - 0.045 inch (0.76 - 1.14mm).

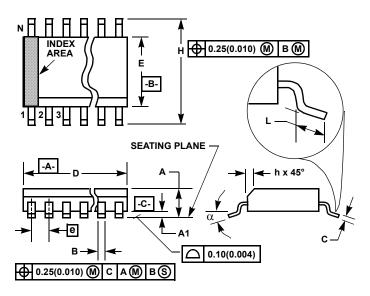
E16.3 (JEDEC MS-001-BB ISSUE D)
16 LEAD DUAL-IN-LINE PLASTIC PACKAGE

|                | INCHES |       | MILLIM   |       |       |
|----------------|--------|-------|----------|-------|-------|
| SYMBOL         | MIN    | MAX   | MIN      | MAX   | NOTES |
| Α              | -      | 0.210 | -        | 5.33  | 4     |
| A1             | 0.015  | -     | 0.39     | -     | 4     |
| A2             | 0.115  | 0.195 | 2.93     | 4.95  | -     |
| В              | 0.014  | 0.022 | 0.356    | 0.558 | -     |
| B1             | 0.045  | 0.070 | 1.15     | 1.77  | 8, 10 |
| С              | 0.008  | 0.014 | 0.204    | 0.355 | -     |
| D              | 0.735  | 0.775 | 18.66    | 19.68 | 5     |
| D1             | 0.005  | -     | 0.13     | -     | 5     |
| Е              | 0.300  | 0.325 | 7.62     | 8.25  | 6     |
| E1             | 0.240  | 0.280 | 6.10     | 7.11  | 5     |
| е              | 0.100  | BSC   | 2.54 BSC |       | -     |
| e <sub>A</sub> | 0.300  | BSC   | 7.62 BSC |       | 6     |
| e <sub>B</sub> | -      | 0.430 | -        | 10.92 | 7     |
| L              | 0.115  | 0.150 | 2.93     | 3.81  | 4     |
| N              | 1      | 6     | 16       |       | 9     |

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EN24

# Small Outline Plastic Packages (SOIC)



#### NOTES:

- Symbols are defined in the "MO Series Symbol List" in Section 2.2 of Publication Number 95.
- 2. Dimensioning and tolerancing per ANSI Y14.5M-1982.
- Dimension "D" does not include mold flash, protrusions or gate burrs.
   Mold flash, protrusion and gate burrs shall not exceed 0.15mm (0.006 inch) per side.
- 4. Dimension "E" does not include interlead flash or protrusions. Interlead flash and protrusions shall not exceed 0.25mm (0.010 inch) per side.
- The chamfer on the body is optional. If it is not present, a visual index feature must be located within the crosshatched area.
- 6. "L" is the length of terminal for soldering to a substrate.
- 7. "N" is the number of terminal positions.
- 8. Terminal numbers are shown for reference only.
- The lead width "B", as measured 0.36mm (0.014 inch) or greater above the seating plane, shall not exceed a maximum value of 0.61mm (0.024 inch).
- Controlling dimension: MILLIMETER. Converted inch dimensions are not necessarily exact.

M16.15 (JEDEC MS-012-AC ISSUE C)
16 LEAD NARROW BODY SMALL OUTLINE PLASTIC PACKAGE

| WELAD NAMEOUS BOST OFFICE OF TENET FACTOR ACTAGE |           |        |          |       |       |  |
|--|-----------|--------|----------|-------|-------|--|
|  | INCHES    |        | MILLIN   |       |       |  |
| SYMBOL   | MIN       | MAX    | MIN      | MAX   | NOTES |  |
| Α  | 0.0532    | 0.0688 | 1.35     | 1.75  | -     |  |
| A1   | 0.0040    | 0.0098 | 0.10     | 0.25  | -     |  |
| В  | 0.013     | 0.020  | 0.33     | 0.51  | 9     |  |
| С  | 0.0075    | 0.0098 | 0.19     | 0.25  | -     |  |
| D  | 0.3859    | 0.3937 | 9.80     | 10.00 | 3     |  |
| Е  | 0.1497    | 0.1574 | 3.80     | 4.00  | 4     |  |
| е  | 0.050 BSC |        | 1.27 BSC |       | -     |  |
| Н  | 0.2284    | 0.2440 | 5.80     | 6.20  | -     |  |
| h  | 0.0099    | 0.0196 | 0.25     | 0.50  | 5     |  |
| L  | 0.016     | 0.050  | 0.40     | 1.27  | 6     |  |
| N  | 16        |        | 16       |       | 7     |  |
| α  | 0°        | 8°     | 0°       | 8°    | -     |  |

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